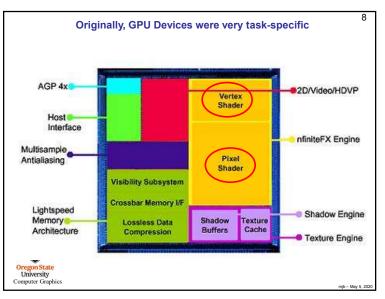
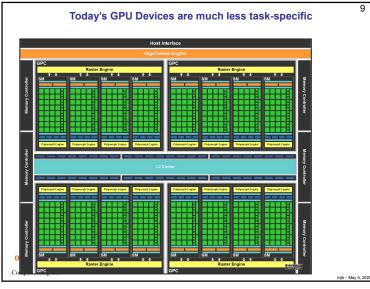
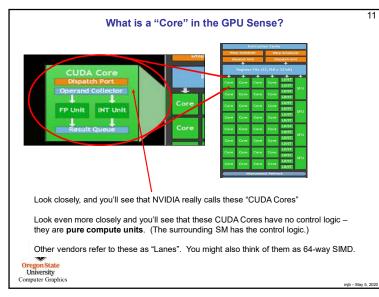
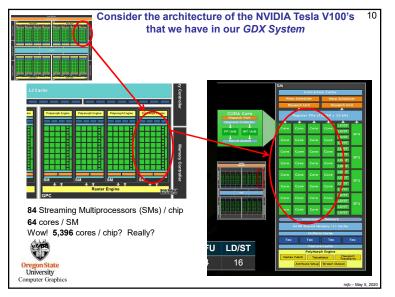


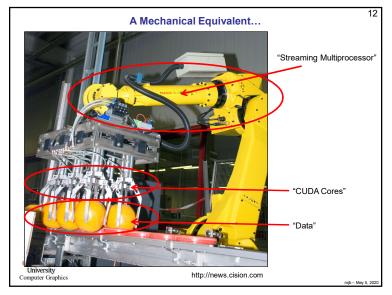
,

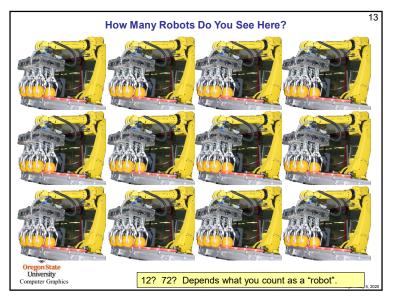


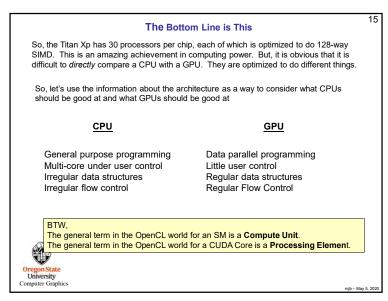




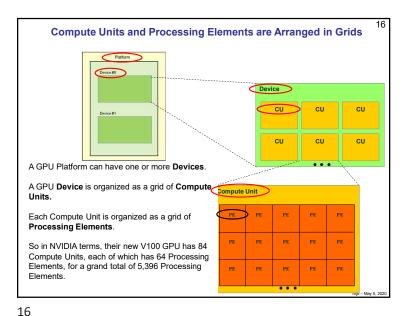


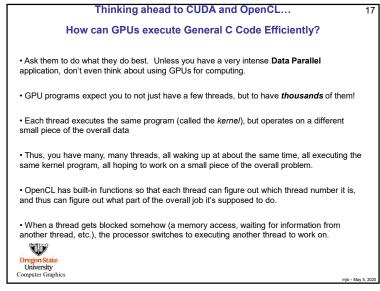






			A Sp	ec Shee	t Example	9	
	Streaming						
	Multiprocesso	rs Cl	JDA Cores p	er SM			
	viulupiocesso	, 3 OC		0. 0			
	/	/					
[	Tesla Product	Tesla K40	Tesla M40	Tesla P100	Tesla V100		
	GPU	GK180 (Kerner)	GM200 (Maxwell)	GP100 (Pascal)	GV100 (Volta)		
4	SMs	15	24	56	80		
	TPCs	15	24	28	40		
	FP32 Cores / SM	192	128	64	64		
	FP32 Cores / GPU	2880	3072	3584	5120		
	FP64 Cores / SM	64	4	32	32		
	FP64 Cores / GPU	960	96	1792	2560		
	Tensor Cores / SM	NA	NA	NA	8		
- [	Tensor Cores / GPU	NA	NA	NA	640		
[	GPU Boost Clock	810/875 MHz	1114 MHz	1480 MHz	1530 MHz		
	Peak FP32 TFLOPS <sup>1</sup>	5	6.8	10.6	15.7		
	Peak FP64 TFLOPS <sup>1</sup>	1.7	.21	5.3	7.8		
- [	Peak Tensor TFLOPS1	NA	NA	NA	125		
	Texture Units	240	192	224	320		
	Memory Interface	384-bit GDDR5	384-bit GDDR5	4096-bit HBM2	4096-bit HBM2		
[	Memory Size	Up to 12 GB	Up to 24 GB	16 GB	16 GB		
	L2 Cache Size	1536 KB	3072 KB	4096 KB	6144 KB		
	Shared Memory Size / SM	16 KB/32 KB/48 KB	96 KB	64 KB	Configurable up to 96 KB		
	Register File Size / SM	256 KB	256 KB	256 KB	256KB		
	Register File Size / GPU	3840 KB	6144 KB	14336 KB	20480 KB		
4	TDP	235 Watts	250 Watts	300 Watts	300 Watts		
0	Transistors	7.1 billion	8 billion	15.3 billion	21.1 billion		
	GPU Die Size	551 mm²	601 mm <sup>2</sup>	610 mm <sup>2</sup>	815 mm <sup>2</sup>		
	Manufacturing Process	28 nm	28 nm	16 nm FinFET+	12 nm FFN	NVIDIA	





<sup>17</sup> 





## Particle Systems are a great example.

- 1. Have one thread per each particle.
- 2. Put all of the initial parameters into an array in GPU memory.
- 3. Tell each thread what the current Time is.
- 4. Each thread then computes its particle's position, color, etc. and writes it into arrays in GPU memory.
- 5. The CPU program then initiates OpenGL drawing of the information in those arrays.

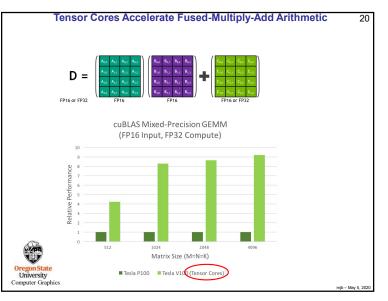
Note: once setup, the data never leaves GPU memory!



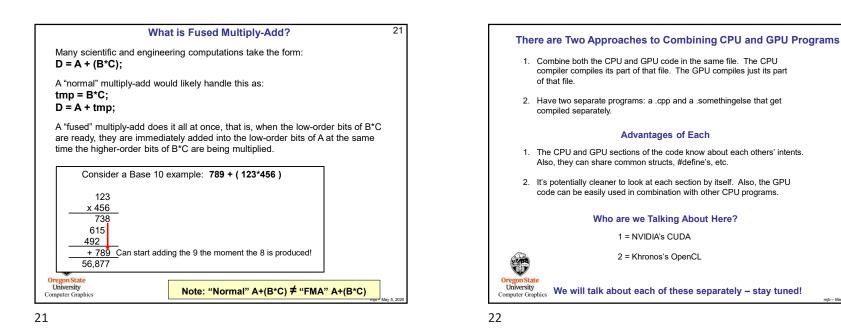
Ben Weiss

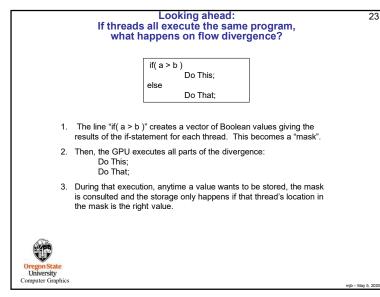
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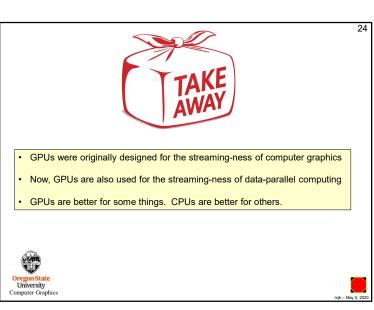








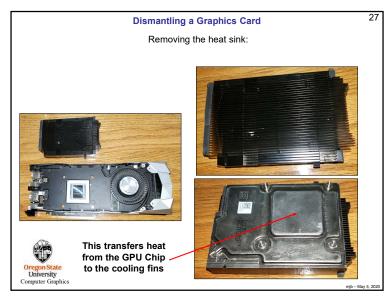


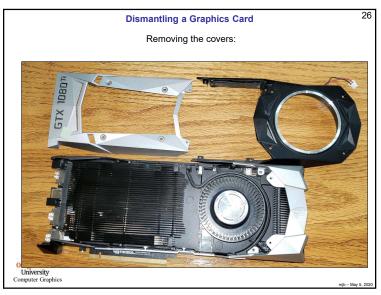


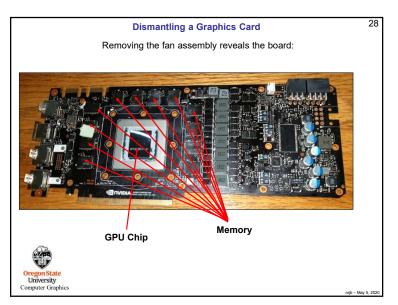


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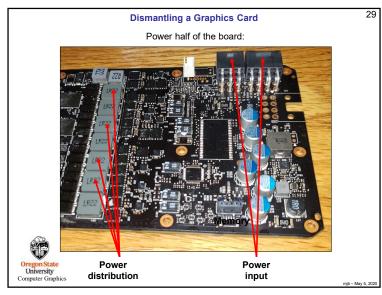


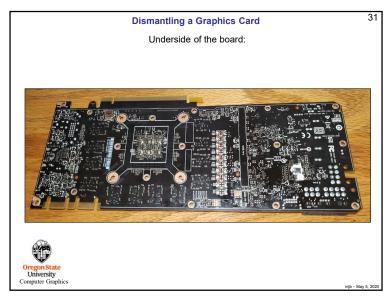


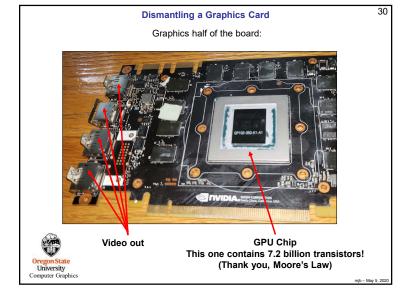


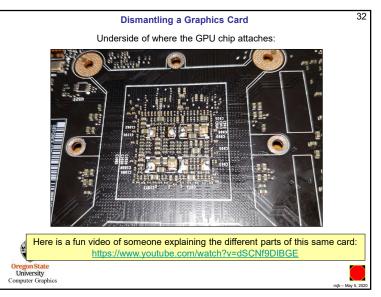






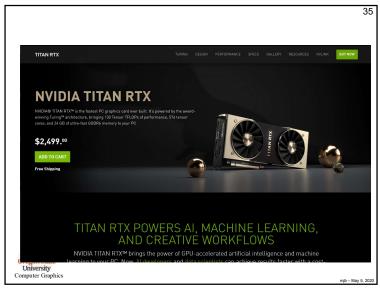






GPU	Kepler GK180	Maxwell GM200	Pascal GP100	Volta GV100
Compute Capability	3.5	5.2	6.0	7.0
Threads / Warp	32	32	32	32
Max Warps / SM	64	64	64	64
Max Threads / SM	2048	2048	2048	2048
Max Thread Blocks / SM	16	32	32	32
Max 32-bit Registers / SM	65536	65536	65536	65536
Max Registers / Block	65536	32768	65536	65536
Max Registers / Thread	255	255	255	255 <sup>1</sup>
Max Thread Block Size	1024	1024	1024	1024
FP32 Cores / SM	192	128	64	64
Ratio of SM Registers to FP32 Cores	341	512	1024	1024
Shared Memory Size / SM	16 KB/32 KB/ 48 KB	96 KB	64 KB	Configurable up to 96 KB

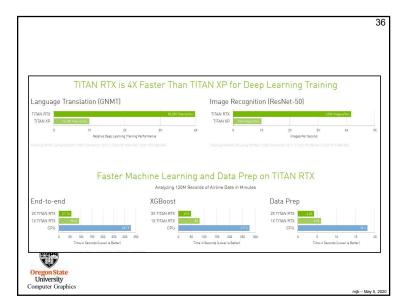
Oregon State University Computer Graphics

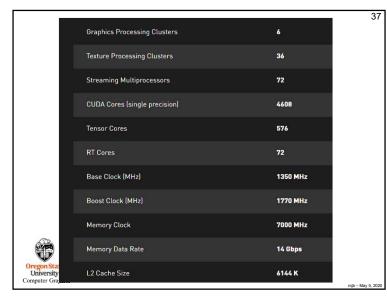


Tesla Product	Tesla K40	Tesla M40	Tesla P100	Tesla V100
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Manufacturing Process	28 nm	28 nm	16 nm FinFET+	12 nm FFN

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	Total Video Memory	24 GB GDDR6
	Memory Interface	384-bit
	Total Memory Bandwidth	672 GB/s
	Texture Rate (Bilinear)	510 GigaTexels/sec
1	Fabrication Process	12 nm FFN
	Transistor Count	18.6 Billion
	Connectors	3 x DisplayPort , 1 x HDMI, 1 x USB Type-C
	OS Certification	Windows 7 64-bit, Windows 10 64-bit (April 2018 Update or later),Linux 64-bit
	Form Factor	Dual Slot
	Power Connectors	Two 8-pin
	Recommended Power Supply	650 Watts
(	Thermal Design Power (TDP)'	280 Watts
Orej Un omp	Thermal Threshold"	89° C